Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	897806	@pd>="20050613"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/07 08:44
L2	2107	(250/370.09 250/370.11 250/580 250/581 250/582).ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/07 08:44
L3	104	1 and 2	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/07 08:44
L4	988233	(radiation xray x-ray x adj ray)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/07 08:44
L5	6654854	detect$3 sens$3 measur$3 measurement	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/07 08:45
L6	5390639	support$3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/07 08:45
L7	2330543	substrate wafer	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/07 08:45
L9	2899090	imag$3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/07 08:45

L10	7320058	gap hole opening hollow recess protrusion	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/07 08:46
L12	11413813	hous$3 case casing enclosure contain$3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/07 08:47
L13	10330245	panel plate film sheet layer	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/07 08:46
L14	326055	(thermal temperature) with (expand$3 expansion)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/07 08:47
L15	1884143	(reinforc$3 reinforcement stabiliz$3 stabilization strengthen$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/07 08:48
L16	63039	honeycomb$3 honey-comb$3 (honey adj comb$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/07 08:48
L17	218083	cassette	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/07 08:49
L18	1795651	(solid-state) (solid adj state) semiconductor	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/07 08:49

L19	684768	weight with (reduc$3 reduction light$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/07 08:50
L20	4994	(4 with 5) and 7 and 9 and (10 with (6 7)) and 12 and 13	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/07 08:56
L21	275	20 and ((6 15) with (7 13)) and (4 with (13 17)) and (19) and (9 same 4)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/07 09:11
L22	1	20 and (16 with (7 13)) and (18 same 5) and (19 with (7 13 17))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/07 09:10
L23	316	20 and (250/336.1 250/338.1 250/349 250/366 250/369 250/370. 01 250/370.08 250/370.09 250/370. 11 250/394 250/580 250/581 250/582).ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/07 09:10
L24	297	23 not (21 22)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/07 09:10
L25	469	20 and 1	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/07 09:35
L26	408	25 not (21 22 23)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/07 09:11
L27	7	("5276329" | "5661309" | "5804832").PN. OR ("6025598"). URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/12/07 09:16
L28	0	("2004/0211909").URPN.	USPAT	OR	ON	2005/12/07 09:22

L30	9	("20020041977"|"20030066972"|"20030134087"|"20030160187"|"4733089"|"4769549"|"4851690"|"5055681"|"6376844").PN.	US-PGPUB; USPAT	OR	ON	2005/12/07 09:22